

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China







Motor Driver, H-bridge, Forward / Reverse

Overview

The LV8762T is an 1ch H-bridge driver that can control four operation modes (forward, reverse, brake, and standby) of a motor. The IC is optimal for use in driving brushed DC motors for office equipment.

Features

- Forward/reverse H-bridge motor driver: 1 channel
- I_{O} max = 1A
- Built-in current limiter
- Current limit mask function
- · Built-in thermal shutdown circuit
- · Alert signal output
- Single power supply
- Built-in short-circuit protection function (selectable from latch-type or auto reset-type).

Applications

- Brush DC Motors
- Computing & Peripherals
- Industrial

Specifications

Absolute Maximum Ratings at $Ta = 25^{\circ}C$ (Note 1,3,4)

Symbol	Conditions	Ratings	Unit
VM max		36	V
I _O peak	tw ≤ 10ms, duty 20%	1.5	Α
I _O max		1.0	Α
V _{IN} max	ST, IN1, IN2, EMM	-0.3 to +6	V
V _{EMO}		-0.3 to +6	V
Pd max	Mounted on a specified board. (Note 2)	1.4	W
Topr		-20 to +85	°C
Tstg		-55 to +150	°C
	VM max I _O peak I _O max V _{IN} max V _{EMO} Pd max Topr	VM max I _O peak tw ≤ 10ms, duty 20% I _O max V _{IN} max ST , IN1 , IN2 , EMM VEMO Pd max Mounted on a specified board. (Note 2) Topr	VM max 36 I _O peak tw ≤ 10ms, duty 20% 1.5 I _O max 1.0 V _{IN} max ST , IN1 , IN2 , EMM -0.3 to +6 VEMO -0.3 to +6 Pd max Mounted on a specified board. (Note 2) 1.4 Topr -20 to +85

Stresses exceeding those listed in the Maximum Rating table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- 2. Specified circuit board: 57mm×57mm×1.6mm, glass epoxy both-type board.
- 3. Absolute maximum ratings represent the value which cannot be exceeded for any length of time
- 4. Even when the device is used within the range of absolute maximum ratings, as a result of continuous usage under high temperature, high current, high voltage, or drastic temperature change, the reliability of the IC may be degraded. Please contact us for the further details



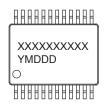
ON Semiconductor®

www.onsemi.com



TSSOP24 (225mil)

GENERIC MARKING DIAGRAM



XXXXX = Specific Device Code Y = Year M = Month DDD = Additional Traceability Data

ORDERING INFORMATION

Ordering Code: LV8762T-TLM-H LV8762T-MPB-H

Package TSSOP24 (225mil) (Pb-Free / Halogen Free)

Shipping (Qty / packing) 2000 / Tape & Reel --- (TLM) 70 / Fan-Fold --- (MPB)

† For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D. http://www.onsemi.com/pub_link/Collateral/BRD8011-D.PDF

Recommended Operating Ranges at Ta = 25°C (Note 5)

Parameter	Symbol	Conditions	Ratings	Unit
Supply voltage range	VM		9 to 32	V
VREF input voltage	VREF		0 to 3	V
Logic input voltage	V _{IN}	ST , IN1 , IN2 , EMM	0 to 5.5	V

^{5.} Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

Electrical Characteristics at Ta = 25°C, VM = 24 V, VREF = 1.5 V (Note 6)

Parameter		Symbol	Symbol Conditions		Ratings		
		Symbol			typ	max	Unit
General					<u> </u>		
Standby mode current drain		IMst	ST = "L"		100	400	μА
Operating mode curr	ent drain	IM	ST = "H", IN1 = "H", IN2 = "L", with no load		3	5	mA
REG5 output voltage)	VREG	I _O = -1mA	4.5	5	5.5	V
Thermal shutdown to	emperature	TSD	Design guarantee (Note 7)	150	180	200	°C
Thermal hysteresis v	vidth	ΔTSD	Design guarantee (Note 7)		40		°C
Output block							
Output on resistance	,	RonU	I _O = 1A, upper side ON resistance		0.75	0.97	Ω
		RonD	I _O = -1A, under side ON resistance		0.5	0.65	Ω
Output leakage curre	ent	l _O leak	V _O = 32V			50	μА
Diode forward voltag	e	VD	ID = -1A		1.2	1.4	V
Rising time		tr	10% to 90%		100	200	ns
Falling time		tf	90% to 10%		100	200	ns
Input output delay tin	ne	tpLH	IN1 to OUTA, IN2 to OUTB (L \rightarrow H)		550	750	ns
		tpHL	IN1 to OUTA, IN2 to OUTB (H \rightarrow L)		550	750	ns
Control system inp	ut block						
Logic input voltage	High	V _{IN} H	ST , IN1 , IN2 , EMM	2.0		5.5	V
	Low	V _{IN} L	1	0		0.8	V
Logic pin input current 1		I _{IN} L	ST, IN1, IN2, EMM V _{IN} = 0.8V	4	8	12	μА
		I _{IN} H	V _{IN} = 5V	30	50	70	μА
VREF input current		IREF	VREF = 1.5V	-0.5			μА
Current limit comparator threshold voltage		Vtlim	VREF = 1.5V	0.291	0.3	0.309	V
CHOP pin charge cu	rrent	ІСНОР		-6.5	-5	-3.5	μА
CHOP pin threshold	voltage	VtCHOP		0.8	1	1.2	V
CMK pin charge curr	ent	ICMK		-32.5	-25	-17.5	μА
CMK pin threshold v	oltage	Vt _{CMK}		1.2	1.5	1.8	V
Charge pump block	(•				•	
Step-up voltage		VGH	VM = 24V	27.7	28.7	29.7	V
Rising time		tONG	VG = 0.1μF		250	550	μS
Oscillation frequency Fcp		Fcp		90	125	155	kHz
Short-circuit protec	tion block	•	•	<u> </u>	•	<u> </u>	
EMO output saturation	on voltage	V _{EMO}	I _{EMO} = 1mA			0.4	V
SCP pin charge curre	ent	I _{SCP}	SCP = 0V	-6.5	-5	-3.5	μА
Comparator threshold voltage		VtSCP		0.8	1	1.2	V

^{6.} Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

^{7.} Design guarantee value and no measurement is made.

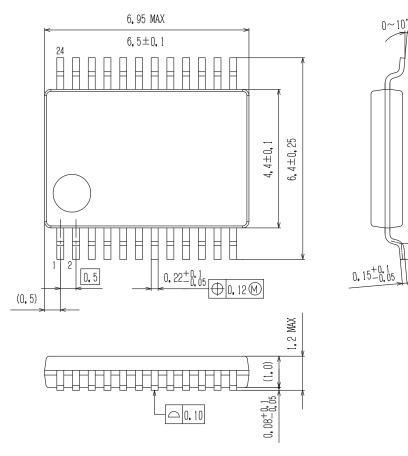
0,5±0,2

Package Dimensions

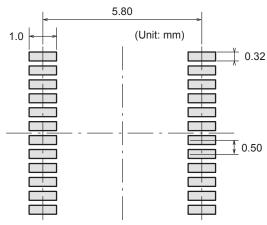
unit: mm

TSSOP24 4.4x6.5 / TSSOP24 (225 mil)

CASE 948BA ISSUE A



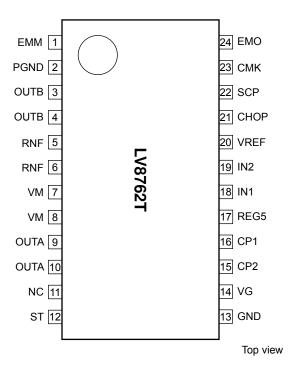
SOLDERING FOOTPRINT*

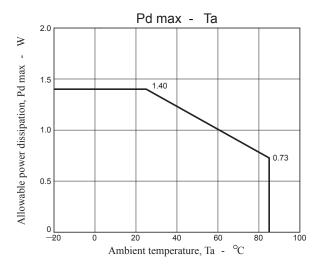


NOTE: The measurements are not to guarantee but for reference only.

^{*}For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

Pin Assignment

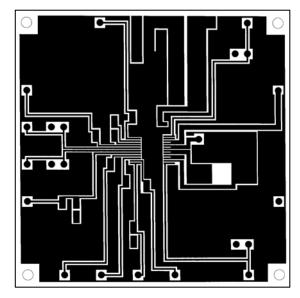




Substrate Specifications (Substrate recommended for operation of LV8762T)

Size : $57\text{mm} \times 57\text{mm} \times 1.6\text{mm}$ (two-layer substrate)

Material : Glass epoxy both-type board



L1 : Copper wiring pattern diagram

L2 : Copper wiring pattern diagram

Cautions

1) For the set design, employ the derating design with sufficient margin.

Stresses to be derated include the voltage, current, junction temperature, power loss, and mechanical stresses such as vibration, impact, and tension.

Accordingly, the design must ensure these stresses to be as low or small as possible.

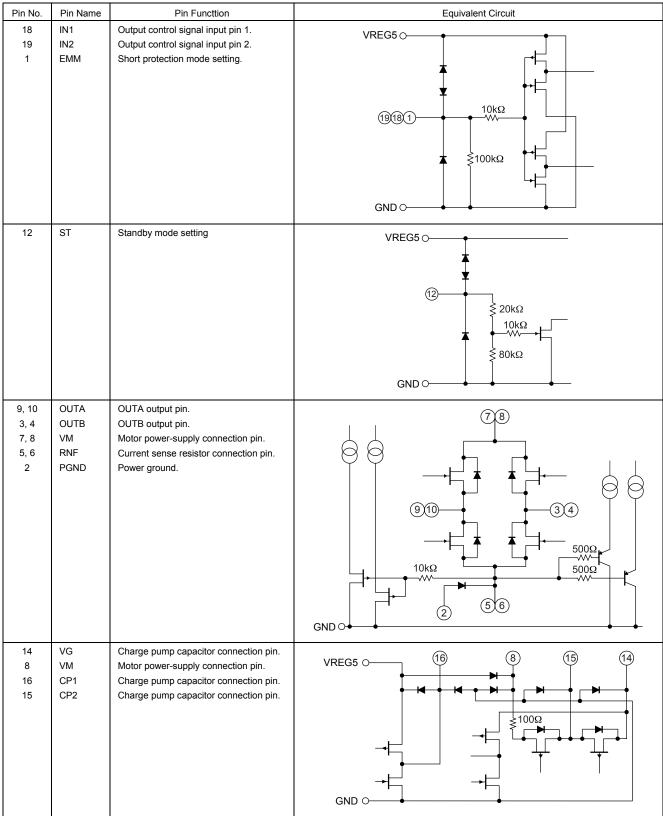
The guideline for ordinary derating is shown below:

- (1)Maximum value 80% or less for the voltage rating
- (2)Maximum value 80% or less for the current rating
- (3)Maximum value 80% or less for the temperature rating
- 2) After the set design, be sure to verify the design with the actual product.

Confirm the solder joint state and verify also the reliability of solder joint for the Exposed Die-Pad, etc.

Any void or deterioration, if observed in the solder joint of these parts, causes deteriorated thermal conduction, possibly resulting in thermal destruction of IC.

Pin Functions



Continued on next page.

Continued from preceding page

	om preceding p		
Pin No.	Pin Name	Pin Functtion	Equivalent Circuit
20	VREF	Reference voltage input pin for output current limit setting.	VREG5 0 500Ω GND 0
17	REG5	Internal reference voltage output pin.	Δ Δ Δ Δ Δ Δ Δ Δ Δ Δ Δ Δ Δ Δ Δ Δ Δ Δ Δ
24	EMO	Alert signal output	VREG5 O
21 22	CHOP SCP	Capacitor connection for current limit break time setting Capacitor connection for short detection time setting	WREG5 O

Continued on next page.

Pin No.	Pin Name	Pin Functtion	Equivalent Circuit
23	CMK	Capacitor connection for current limit mask setting	VREG5 Ο \$\\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\

Description of operation

1.Input Pin Function

Each input terminal has the function to prevent the flow of the current from an input to a power supply. Therefore, Even if a power supply (VM) is turned off in the state that applied voltage to an input terminal, the electric current does not flow into the power supply.

1-1) Chip enable function

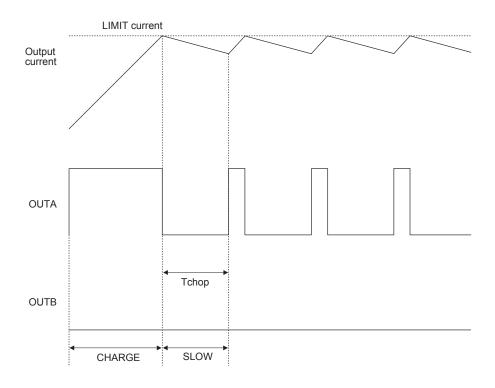
This IC is switched between standby and operating mode by setting the ST pin. In standby mode, the IC is set to power-save mode and all logic is reset. In addition, the internal regulator circuit and charge pump circuit do not operate in standby mode.

ST	mode	Internal regulator	Charge pump
"L" or OPEN	Standby mode	standby	standby
"H"	Operation mode	operation	operation

1-2)DCM output control logic

Contol Input			Output		Made	
ST	IN1	IN2	OUTA	OUTB	Mode	
L	*	*	OFF	OFF	Standby	
Н	L	L	OFF	OFF	Output OFF	
Н	Н	L	Н	L	CW (forward)	
Н	L	Н	L	Н	CCW (reverse)	
Н	Н	Н	L	L	Brake	

1-3)Current limit control timing chart



1-4) Setting the time of current limit brake value

This IC can set the time of the current limit break by connecting the capacitor with CHOP-GND.

The value of the capacitor is decided according to the following expression.

brake time:
$$T_{CHOP} \approx C_{CHOP} \times Vt_{CHOP} \div I_{CHOP}$$
 [sec]
 Vt_{CHOP} : $CHOP$ comparator threshold voltage. $CHOP$: $CHOP$ charge current. $CHOP$: $CHOP$ charge current. $CHOP$: $CHOP$

1-5)Setting the current limit value

The current limit value of the DCM driver is determined by the VREF voltage and the resistance (RNF) connected across the RNF and GND pins using the following formula:

$$\begin{split} & Ilimit \ [A] \approx (VREF \ [V] \div 5) \div RNF \ [\Omega]) \\ & Assuming \ VREF = 1.5V, \ RNF = 1\Omega, \ the \ current \ limit \ is : \\ & Ilimit = 1.5V \div 5 \div 1 \ \Omega = 0.3 \ A \end{split}$$

1-6) Setting the mask of current limit

CMK	mask of current limit
"L"	no operation
"H" or OPEN	operation

This function can be switched by CMK pin.

This function can prevent the current limit from working by the motor start-up current when the current limit value is set low.

1-7) Setting the time of the mask of current limit

This IC can set the time of the mask of current limit by connection the capacitor with CMK-GND.

The value of the capacitor is decided according to the following expression.

Time of mask:
$$T_{CMK} \approx C_{CMK} \times Vt_{CMK} \div I_{CMK}$$
 [sec]
$$Vt_{CMK}:CMK \ comparator \ threshold \ voltage. \ TYP = 1.0 \ [V]$$

$$I_{CMK}:CMK \ charge \ current. \ TYP = 25 \ [\mu A]$$
 ex. $C_{CMK} = 0.1 \ [\mu F]$
$$T_{CMK}[sec] = 0.1 \ [\mu F] \times 1.5 \ [V] \div 25 \ [\mu A] = 6 [ms]$$

2. Output short-circuit protection function

Thils IC incorporates an output short-circuit protection circuit. It turns the output off to prevent destruction of the IC if a problem such as an output pin being shorted to the motor power supply or ground occurs.

Then short-circuit detected, alart signal is assert to EMO pin.

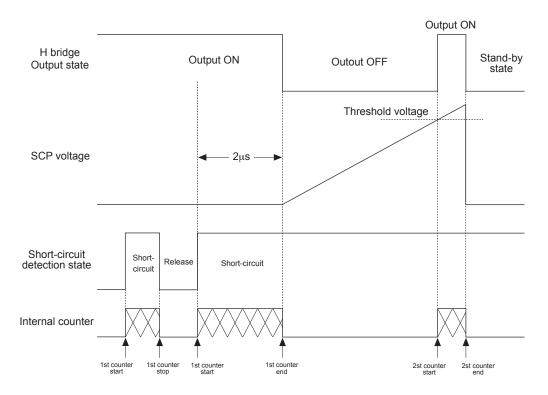
2-1) Output short protect mode

This function can be switched by EMM pin. EMM pin is L or OPEN then latch method, H then auto-retry method.

EMM Pin	Method
"L" or OPEN	Latch
"H"	Auto retry

2-2) Protection function operation (Latch method)

The short-circuit protection circuit is activated when it detects the output short-circuit state. If the short-circuit state continues for the internally preset period ($\approx 2~\mu s$), the protection circuit turns off the output from which the short-circuit state has been detected. Then it turns the output on again after a lapse of the timer latch time (TSCP) described later. If the short-circuit state is still detected, it changes all the outputs to the standby mode and retains the state. The latched state is released by setting the ST to L.



2-3) Protection function operation (Auto retry method)

In this mode, short-protection function try repeatedly to detecting short-circuit.

The short-circuit detection circuit operates when a short output is detected as well as the latch method. The output is switched to the standby mode when the operation of the short-circuit detection circuit exceeds time (T_{SCP}) of the timer latch, and it returns to the turning on mode again after 2 ms (typ). At this time, the switching mode is repeated when is still in the overcurrent mode until the overcurrent mode is made clear.

2-4) Unusual Condition Warning Output Pin (EMO)

The LV8762T is provided with the EMO pin which notifies the CPU of an unusual condition if the protection circuit operates by detecting an abnormal condition of the IC. This pin is of the open-drain output type, and if abnormality is detected, the EMO output becomes (EMO=L) of on.

The EMO pin is placed in the ON state when one of the following conditions occurs.

- 1. Shorting-to-power or shorting-to-ground occurs at the output pin and the output short-circuit protection circuit is activated.
- 2. The IC junction temperature rises and the thermal protection circuit is activated.

2-5)Timer latch-up (TSCP)

The user can set the time at which the outputs are turned off when a short-circuit occurs by connecting a capacitor (C_{SCP}) across the SCP and GND pins. The value of the capacitor (C_{SCP}) can be determined by the following formula :

Timer latch-up : T_{SCP} $T_{SCP} \approx C_{SCP} \times Vt_{SCP} \div I_{SCP}$ [sec]

Vt_{SCP}: Comparator threshold voltage (1 V typical)

ISCP: SCP charge current (5 µA typical)

3. Thermal shutdown function

The thermal shutdown circuit is included, and the output is turned off when junction temperature Tj exceeds 180°C, and the abnormal state warning output(EMO pin) is turned on at the same time.

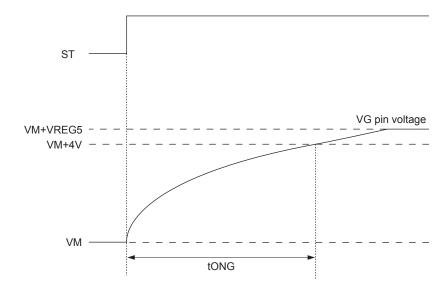
When the temperature falls hysteresis level, output is driven again (automatic restoration) The thermal shutdown circuit doesn't guarantee protection of the set and the destruction prevention because it works at the temperature that is higher than rating (Tjmax = 150°C) of the junction temperature

TSD=180°C (typ) ΔTSD=40°C (typ)

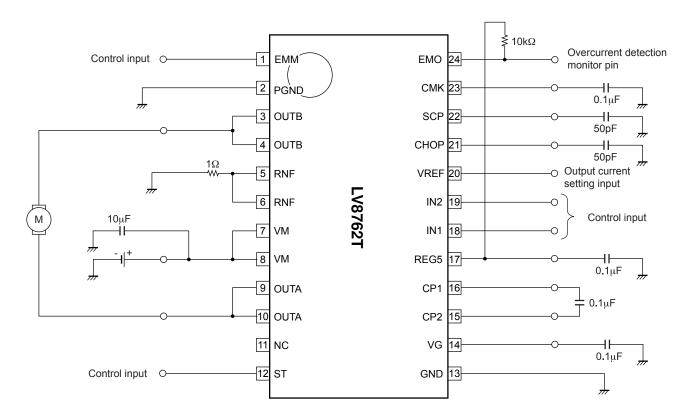
4. Charge pump Circuit

When the ST pin is set High, the charge pump circuit operates and the VG pin voltage is boosted from the VM voltage to the VM+VREG5 voltage.

If the VG pin voltage is not boosted to VM + 4 V or more, the output pin cannot be turned on. Therefore it is recommended that the drive of the motor is started after the time has passed tONG or more.



5. Application Circuit Example



Current limit value

When VREF = 1.5 V,
Ilimit = Vref
$$\div$$
 5 \div RNF
= 1.5 V \div 5 \div 1 Ω = 0.3 A

Setting the current limit regeneration time and short-circuit detection time

$$T_{SCP} \approx C_{SCP} \times Vt_{SCP} \div I_{SCP}$$

= 50 pF × 1 V ÷ 5 μ A = 10 μ s

Setting at current limit mask time

$$\begin{split} T_{CMK} &\approx C_{CMK} \times Vt_{CMK} \div I_{CMK} \\ &= 0.1 \; \mu F \times 1.5 \; V \div 25 \; \mu A = 6 \; ms \end{split}$$

Setting at current limit brake time

$$T_{CHOP} \approx C_{CHOP} \times V_{tCHOP} \div I_{CHOP}$$

= 50 pF × 1 V ÷ 5 μ A = 10 μ s

* The external part constant is a reference value.

ON Semiconductor and the ON Semiconductor logo are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officer